	REVISION DESCRIPTION	APP.	DRW.	DATE	CHANGE No.
3 X					
2 X					
1 X					

ITEM	NAME	Q'TY	MATERIAL /FINISH
3	CONTACT	5	COPPER ALLOY/SELECTIVE GOLD PLATING
2	HOUSING	1	THERMOPLASTIC, GLASS FILLED, 94V-0
1	SHELL	1	COPPER ALLOY

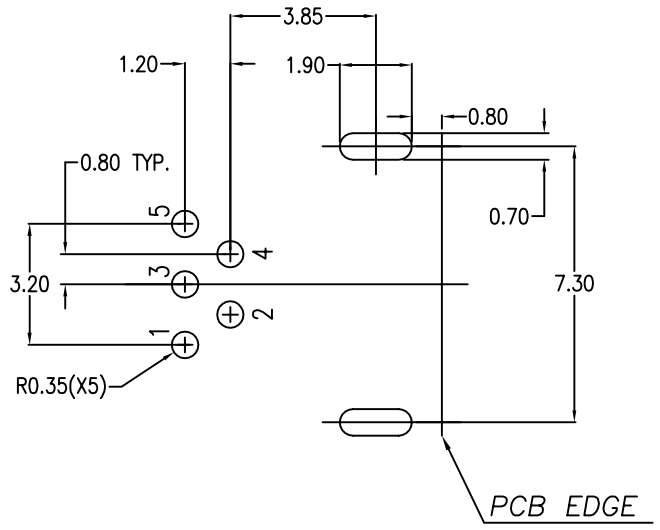
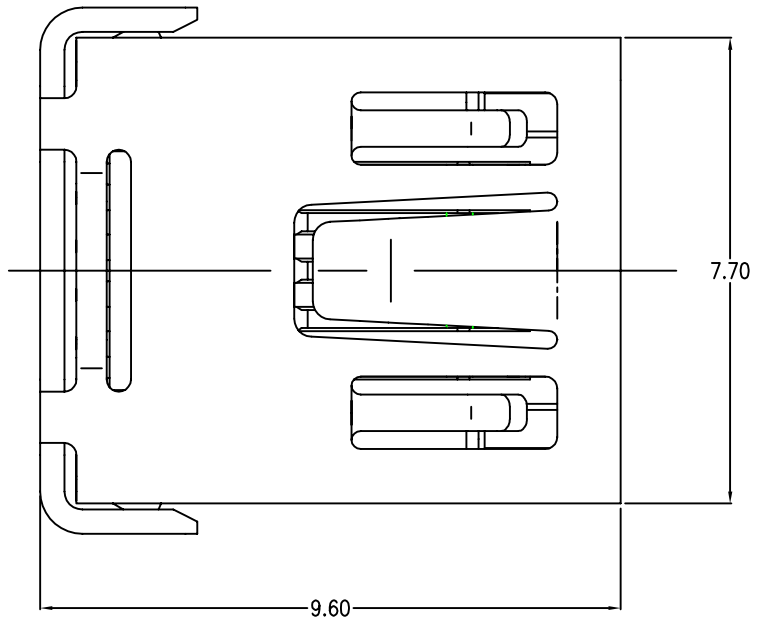
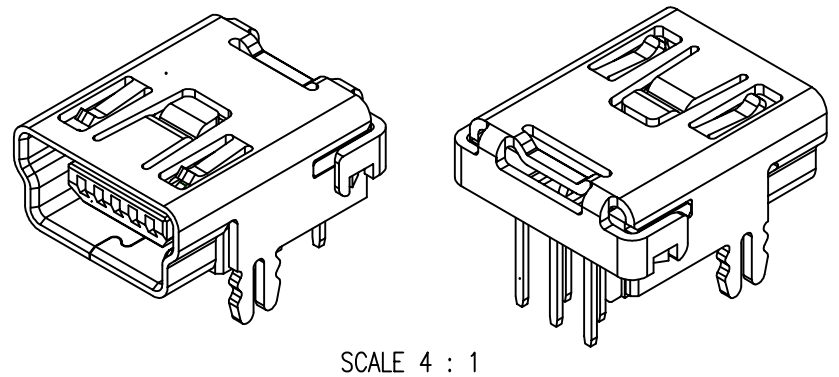
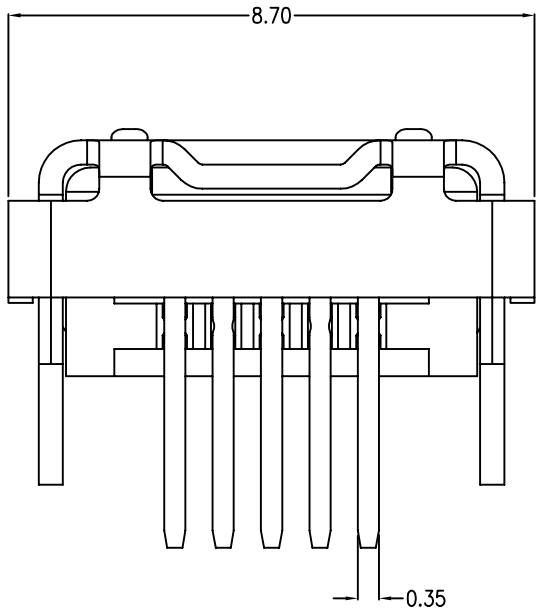


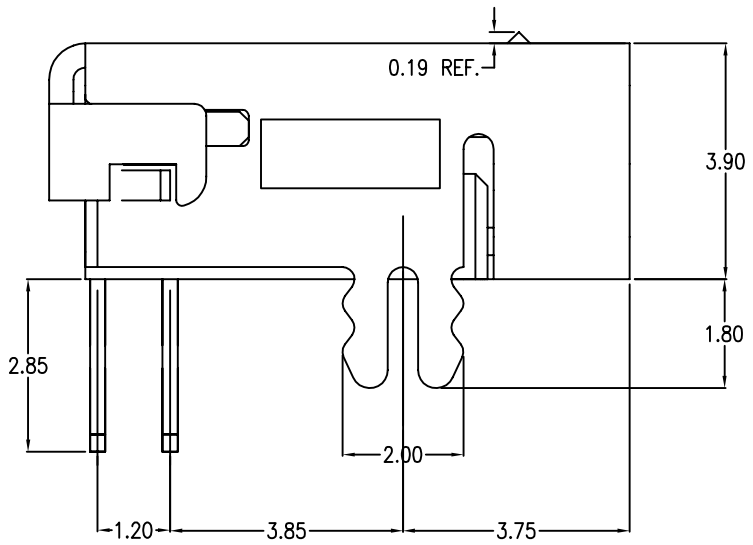
FIGURE A : Printed Circuit Board (PCB) Layout(scale 5 : 1)

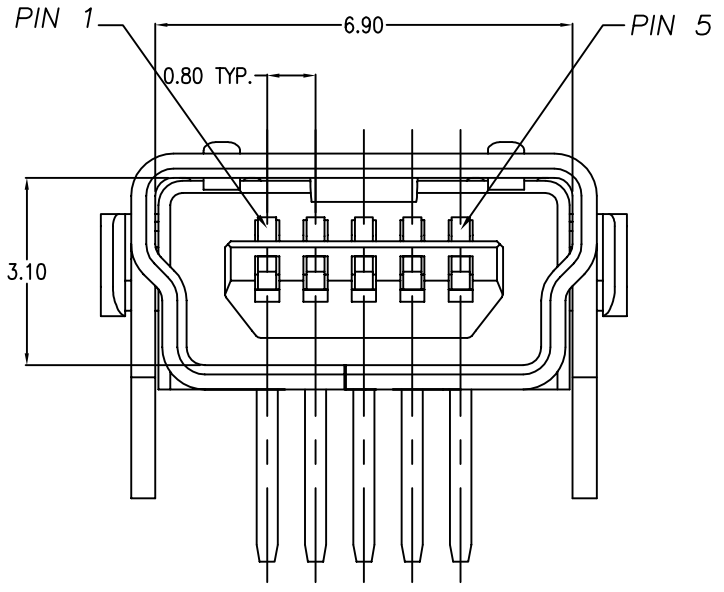




SCALE 4 : 1







Tolerance:

X.	±0.38
X.X	±0.25
X.XX	±0.13
X.XXX	±0.05
X.°	±3.0°
X.X°	±2.0°
X.XX°	±1.0°

		APP.	APP.	CHK.	DRW.	DSGN.
SCALE	8:1		'09/03/26	'09/03/26	'09/03/26	'09/03/26
DIMENTION	MM		K. Abe	K. Abe	R. Yang	R. Yang
ANGLE PROJ	3rd					

YAMAICHI ELECTRONICS USA INC.

CLASS MINICONN, MINI USB MINI-B, RECEP, R/A. T/H TYPE

Part # RZS005U-0001-0

DRW No. YEU-A1173

Sheet No. /

REV. A

A3-001